COMPONENTS MARKED ‘DNP’ SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE          BOARD #: AIP041          REV: A          SUN REV: Not In VersionControl

IGNORE ->  GENERATED : 3/27/2015   2:34:55 PM          TEXAS INSTRUMENTS
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

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<th>PCB VIEWED FROM BOTTOM SIDE</th>
<th>BOARD #: A10041</th>
<th>REV: A</th>
<th>SUN REV: Not In VersionControl</th>
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<th>PLOT NAME = Bottom Assembly Drawing</th>
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